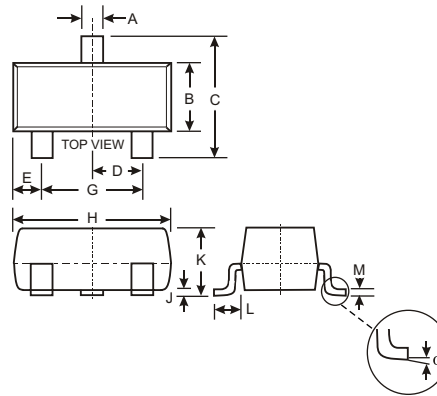


Features

- Lead Free Finish/RoHS Compliant ("P" Suffix designates RoHS Compliant. See ordering information)
- Epoxy meets UL 94 V-0 flammability rating
- Moisture Sensitivity Level 1
- Ideally Suited for Automatic Insertion
- 150°C Junction Temperature
- For Switching and AF Amplifier Applications
- Halogen free available upon request by adding suffix "-HF"

Mechanical Data

- Case: SOT-23, Molded Plastic
- Terminals: Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.008 grams (approx.)



SOT-23		
Dim	Min	Max
A	0.37	0.51
B	1.20	1.40
C	2.30	2.50
D	0.89	1.03
E	0.45	0.60
G	1.78	2.05
H	2.80	3.00
J	0.013	0.10
K	0.903	1.10
L	0.45	0.61
M	0.085	0.180
α	0°	8°
All Dimensions in mm		

Maximum Ratings and Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Charateristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	BC856	-80
		BC857	-50
		BC858	-30
Collector-Emitter Voltage	V_{CEO}	BC856	-65
		BC857	-45
		BC858	-30
Emitter-Base Voltage	V_{EBO}	-5.0	V
Collector Current	I_C	-100	mA
Peak Collector Current	I_{CM}	-200	mA
Peak Emitter Current	I_{EM}	-200	mA
Power Dissipation@ $T_s=50^\circ\text{C}$ (Note1)	P_d	200	mW
Operating & Storage Temperature	T_j, T_{STG}	-55~150	°C

- Note:**
1. Package mounted on ceramic substrate 0.7mm X 2.5cm² area.
 2. Current gain subgroup " C " is not available for BC856



BC856A thru BC858C

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition	
Collector-Base Breakdown Voltage (Note 3)	BC856 BC857 BC858 $V_{(BR)CBO}$	-80 -50 -30	— — —	— — —	V	$I_C = 10\mu\text{A}, I_B = 0$	
Collector-Emitter Breakdown Voltage (Note 3)	BC856 BC857 BC858 $V_{(BR)CEO}$	-65 -45 -30	— — —	— — —	V	$I_C = 10\text{mA}, I_B = 0$	
Emitter-Base Breakdown Voltage (Note 3)	$V_{(BR)EBO}$	-5	—	—	V	$I_E = 1\mu\text{A}, I_C = 0$	
H-Parameters							
Small Signal Current Gain	Current Gain Group A B C	h_{fe} h_{fe} h_{fe}	— — —	200 330 600	— — —	$V_{CE} = -5.0\text{V}, I_C = -2.0\text{mA},$ $f = 1.0\text{kHz}$	
Input Impedance	Current Gain Group A B C	h_{ie} h_{ie} h_{ie}	— — —	2.7 4.5 8.7	k Ω k Ω k Ω		
Output Admittance	Current Gain Group A B C	h_{oe} h_{oe} h_{oe}	— — —	18 30 60	μS μS μS		
Reverse Voltage Transfer Ratio	Current Gain Group A B C	h_{re} h_{re} h_{re}	— — —	1.5×10^{-4} 2×10^{-4} 3×10^{-4}	— — —		
DC Current Gain (Note 3)	Current Gain Group A B C	h_{FE}	125 220 420	180 290 520	250 475 800		$V_{CE} = -5.0\text{V}, I_C = -2.0\text{mA}$
Thermal Resistance, Junction to Substrate Backside	$R_{\theta JSB}$	—	—	320	$^\circ\text{C/W}$		Note 1
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	—	—	625	$^\circ\text{C/W}$	Note 1	
Collector-Emitter Saturation Voltage (Note 3)	$V_{CE(SAT)}$	—	-75 -250	-300 -650	mV	$I_C = -10\text{mA}, I_B = -0.5\text{mA}$ $I_C = -100\text{mA}, I_B = -5.0\text{mA}$	
Base-Emitter Saturation Voltage (Note 3)	$V_{BE(SAT)}$	—	-700 -850	—	mV	$I_C = -10\text{mA}, I_B = -0.5\text{mA}$ $I_C = -100\text{mA}, I_B = -5.0\text{mA}$	
Base-Emitter Voltage (Note 3)	$V_{BE(ON)}$	-600 —	-650 —	-750 -820	mV	$V_{CE} = -5.0\text{V}, I_C = -2.0\text{mA}$ $V_{CE} = -5.0\text{V}, I_C = -10\text{mA}$	
Collector-Cutoff Current (Note 3)	BC856 BC857 BC858 I_{CES} I_{CES} I_{CES} I_{CBO} I_{CBO}	— — — — —	— — — — —	-15 -15 -15 -15 -4.0	nA nA nA nA μA	$V_{CE} = -80\text{V}$ $V_{CE} = -50\text{V}$ $V_{CE} = -30\text{V}$ $V_{CB} = -30\text{V}$ $V_{CB} = -30\text{V}, T_A = 150^\circ\text{C}$	
Gain Bandwidth Product	f_T	100	200	—	MHz	$V_{CE} = -5.0\text{V}, I_C = -10\text{mA},$ $f = 100\text{MHz}$	
Collector-Base Capacitance	C_{CBO}	—	3	—	pF	$V_{CB} = -10\text{V}, f = 1.0\text{MHz}$	
Noise Figure	NF	—	2	10	dB	$V_{CE} = -5.0\text{V}, I_C = 200\mu\text{A},$ $R_S = 2\text{k}\Omega, f = 1\text{kHz},$ $\Delta f = 200\text{Hz}$	

- Notes:
1. Package mounted on ceramic substrate 0.7mm x 2.5cm² area.
 2. Current gain subgroup "C" is not available for BC856.
 3. Short duration pulse test to minimize self-heating effect.